

13 GHz INPUT DIVIDE BY 8 PRESCALER IC FOR SATELLITE COMMUNICATIONS

DESCRIPTION

The μPB1512TU is a silicon germanium (SiGe) monolithic integrated circuit designed as a divide by 8 prescaler IC for satellite communications and point-to-point/multi-point radios.

The package is 8-pin lead-less minimold suitable for surface mount.

This IC is manufactured using our 50 GHz f_{max} UHS2 (Ultra High Speed Process) SiGe bipolar process.

FEATURES

- Operating frequency : $f_{in} = 5$ to 13 GHz
- Low current consumption : $I_{cc} = 48$ mA @ $V_{cc} = 5.0$ V
- High-density surface mounting : 8-pin lead-less minimold
- Supply voltage : $V_{cc} = 4.5$ to 5.5 V
- Division ratio : 8

APPLICATIONS

- Point-to-point/Multi-point radios
- VSAT radios

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPB1512TU-E2	μPB1512TU-E2-A	8-pin lead-less minimold (Pb-Free) ^{Note}	1512	<ul style="list-style-type: none"> • 8 mm wide embossed taping • Pin 5, 6, 7, 8 indicates pull-out direction of tape • Qty 5 kpcs/reel

Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

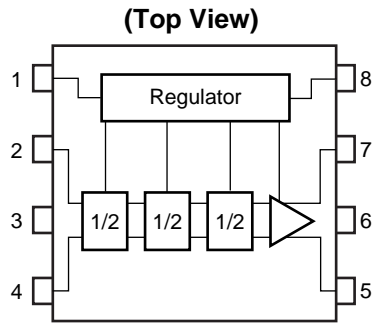
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μPB1512TU

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

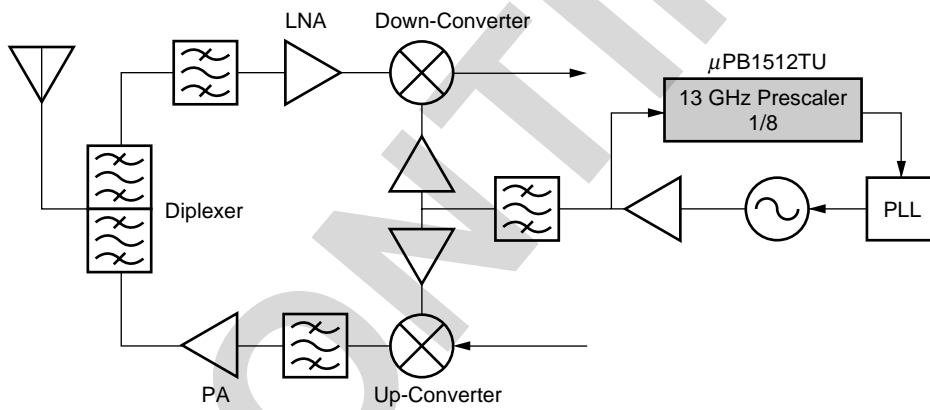
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INTERNAL BLOCK DIAGRAM AND PIN CONNECTIONS



Pin No.	Pin Name
1	Vcc1
2	IN
3	GND
4	$\overline{\text{IN}}$
5	$\overline{\text{OUT}}$
6	GND
7	OUT
8	Vcc2

SYSTEM APPLICATION EXAMPLE



PIN EXPLANATION

Pin No.	Pin Name	Applied Voltage (V)	Function and Applications
1	V _{cc1}	5	Power supply pin. This pin must be equipped with bypass capacitor (example : 100 pF and 10 nF) to minimize ground impedance.
2	IN	–	Signal input pin. This pin should be coupled to signal source with capasitor (example : 100 pF) for DC cut.
3	GND	0	Ground pin. Ground pattern on the board should be formed as widely as possible to minimize ground impedance.
4	$\overline{\text{IN}}$	–	Signal input bypass pin. This pin must be equipped with bypass capacitor (example : 100 pF) to minimize ground impedance.
5	$\overline{\text{OUT}}$	–	Divided frequency output pin. This pin should be coupled to load device with capasitor (example : 100 pF) for DC cut.
6	GND	0	Ground pin. Ground pattern on the board should be formed as widely as possible to minimize ground impedance.
7	OUT	–	Divided frequency output pin. This pin should be coupled to load device with capasitor (example : 100 pF) for DC cut.
8	V _{cc2}	5	Power supply pin. This pin must be equipped with bypass capacitor (example : 100 pF and 10 nF) to minimize ground impedance.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	V _{CC}	T _A = +25°C	6	V
Total Power Dissipation	P _D	T _A = +85°C Note	867	mW
Thermal Resistance (junction to ground paddle)	R _{th(j-c)}	T _A = +85°C Note	75	°C/W
Operating Ambient Temperature	T _A		-40 to +85	°C
Storage Temperature	T _{stg}		-55 to +150	°C

Note Mounted on 33 × 21 × 0.4 mm polyimide PCB, with copper patterning on both sides.

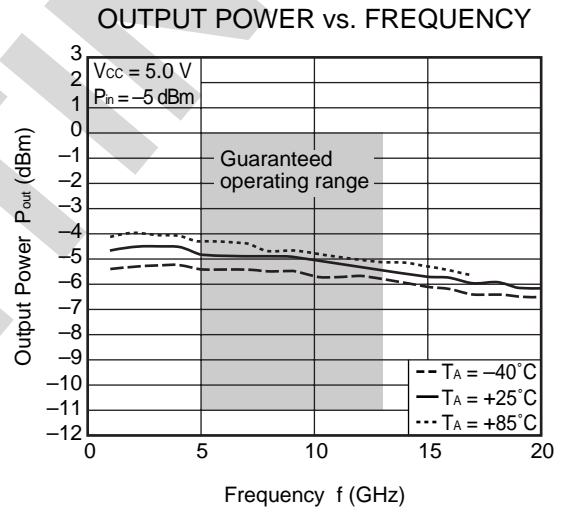
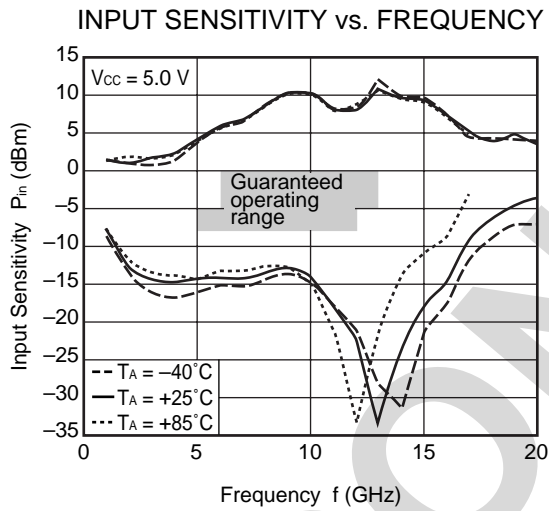
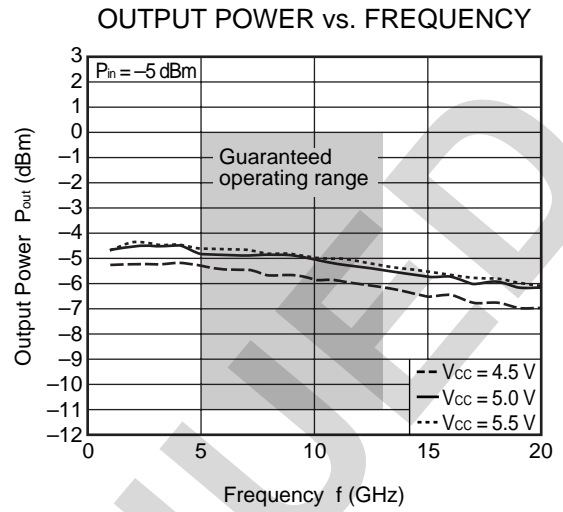
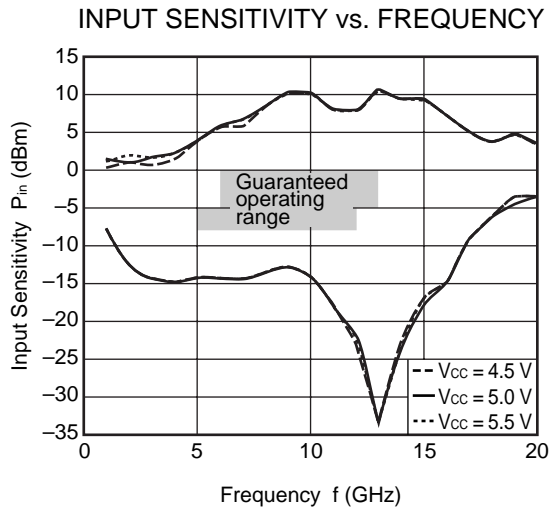
RECOMMENDED OPERATING RANGE

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V _{CC}	4.5	5.0	5.5	V
Operating Ambient Temperature	T _A	-40	+25	+85	°C

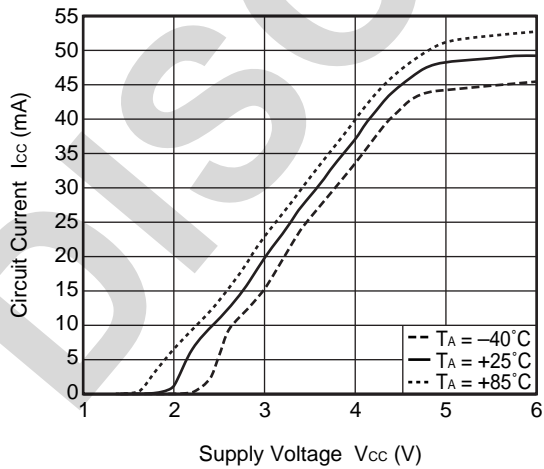
ELECTRICAL CHARACTERISTICS (V_{CC} = 4.5 to 5.5 V, T_A = -40 to +85°C, Z_s = Z_L = 50 Ω)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Circuit Current	I _{CC}	No Signals	-	48	75	mA
Input Sensitivity	P _{in1}	f _{in} = 5 to 6 GHz	-8	-	-5	dBm
	P _{in2}	f _{in} = 6 to 12 GHz	-8	-	0	dBm
	P _{in3}	f _{in} = 12 to 13 GHz	-5	-	0	dBm
★ Output Power	P _{out}	f _{in} = 5 to 13 GHz, single ended, P _{in} = -5 dBm	-11	-4.0	2	dBm

TYPICAL CHARACTERISTICS ($T_A = +25^\circ\text{C}$, unless otherwise specified)



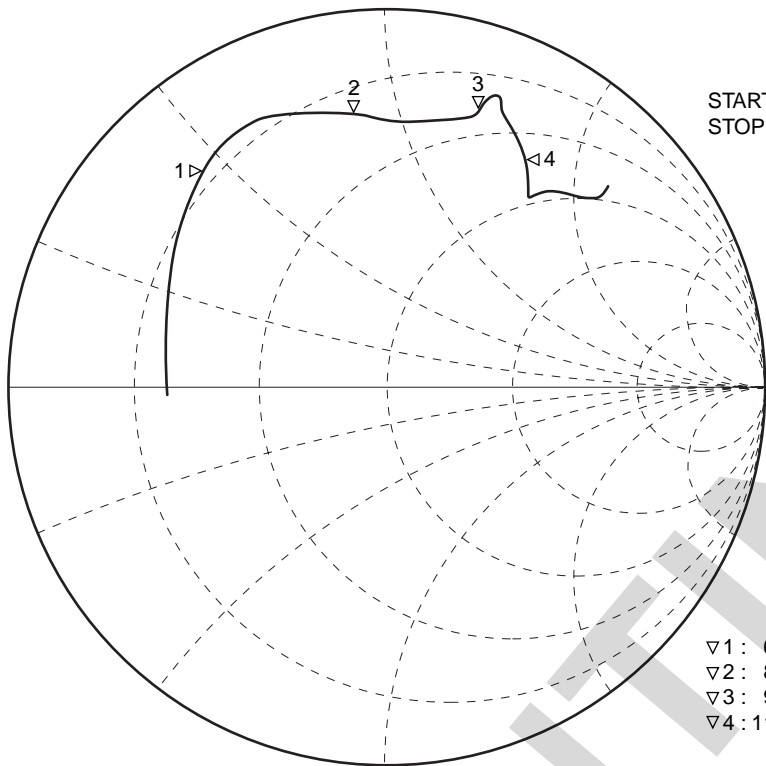
★ **CIRCUIT CURRENT vs. SUPPLY VOLTAGE**



Remark The graphs indicate nominal characteristics.

★ S-PARAMETERS ($T_A = +25^\circ\text{C}$, $V_{CC} = 5.0\text{ V}$)

S₁₁-FREQUENCY

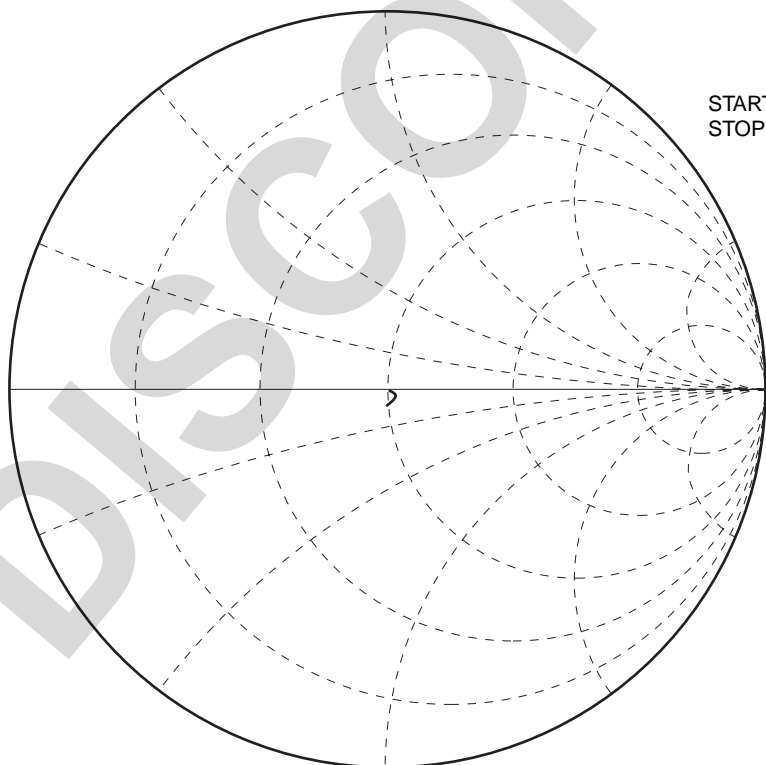


START : 5.0 GHz
STOP : 13.0 GHz

FREQUENCY GHz	MAG	S ₁₁ ANG
5.0	0.574	-177.8
6.0	0.666	146.4
7.0	0.779	120.5
8.0	0.726	97.5
9.0	0.735	75.1
10.0	0.823	68.8
11.0	0.695	58.3
12.0	0.700	46.4
13.0	0.787	42.7

▽1 : 6.5 GHz
▽2 : 8.0 GHz
▽3 : 9.5 GHz
▽4 : 11.0 GHz

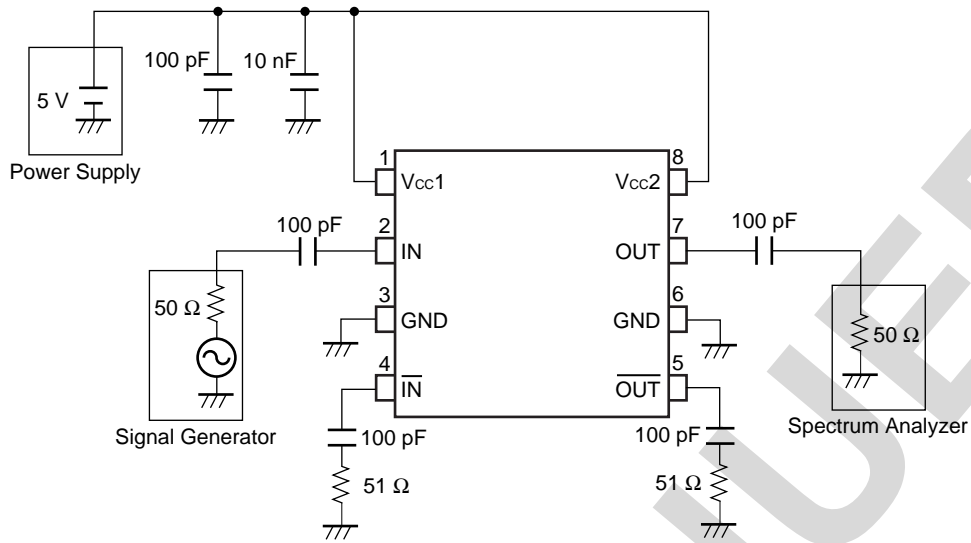
S₂₂-FREQUENCY



START : 0.625 GHz
STOP : 1.625 GHz

FREQUENCY GHz	MAG	S ₂₂ ANG
0.65	0.030	-34.9
0.7	0.029	-38.6
0.8	0.027	-42.9
0.9	0.024	-33.9
1.0	0.021	-46.7
1.1	0.017	-46.8
1.2	0.019	-34.4
1.3	0.010	-26.7
1.4	0.014	-22.8
1.5	0.020	-28.7
1.6	0.034	-58.3

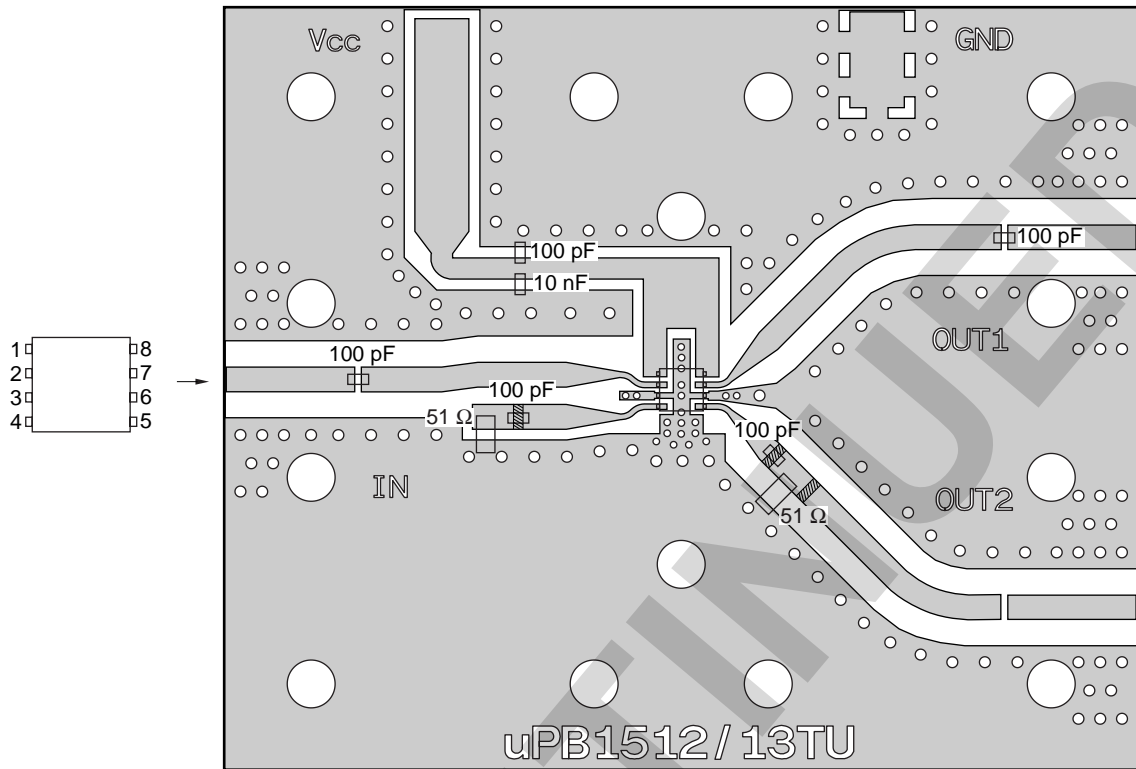
MEASUREMENT CIRCUIT




The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

DISCONTINUED

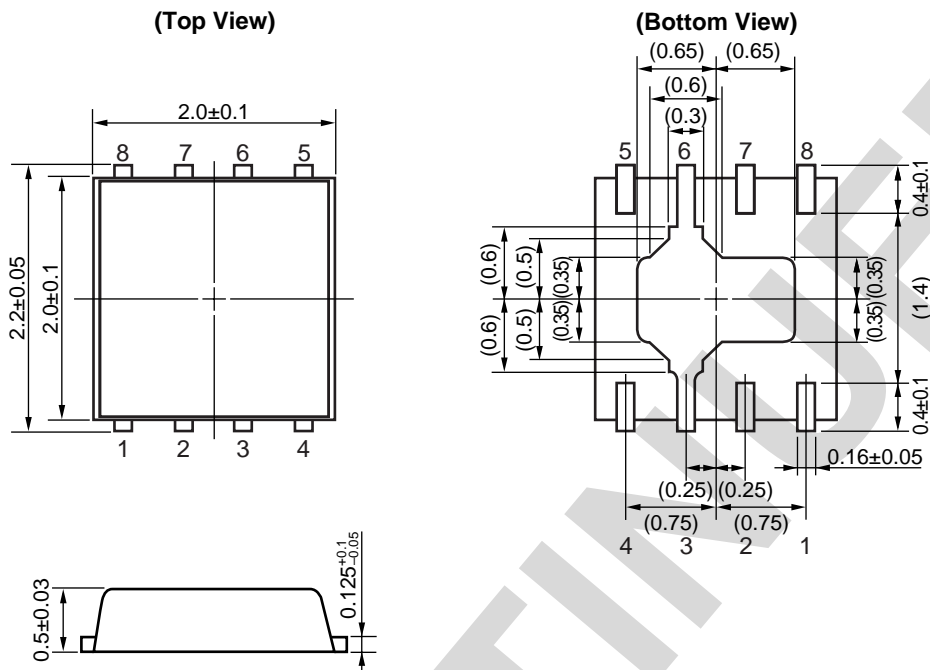
ILLUSTRATION OF THE MEASUREMENT CIRCUIT ASSEMBLED ON EVALUATION BOARD



- Remarks**
1. 33 × 21 × 0.4 mm double-sided copper-clad polyimide PCB
 2. Back side: GND pattern
 3. Solder plated on pattern
 4.  represents cutout
 5. ○: Through holes

PACKAGE DIMENSIONS

8-PIN LEAD-LESS MINIMOLD (UNIT: mm)



DISCONTINUED

NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation).
- (3) Keep the track length of the ground terminals as short as possible.
- (4) Bypass capacitance must be attached to V_{cc} line.
- (5) Exposed heatsink at bottom on package must be soldered to PCB RF/DC ground.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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This status is based on CEL’s understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
		-A	-AZ
Lead (Pb)	< 1000 PPM	Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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